High bandwidth, 40G switch blade design for AdvancedTCA platforms

- PICMG® 3.0 compliant base interface switch
- PICMG 3.1 compliant fabric interface supporting 1G, 10G, and 40G
- Single AMC site
- Optional SATA HDD or SSD
- Optional Telecom clocking support
- Integrated software package
- Designed for NEBS/ETSI compliance

The ATCA-F140 from SMART Embedded Computing is a high performance, high bandwidth 40G switch blade providing the networking infrastructure for SMART EC AXP1440 and Centellis® 4440 platforms. This product is perfect for the most bandwidth intensive telecom and defense applications. Along with the maximum fabric bandwidth available, the ATCA-F140 includes several features to maximize platform cost effectiveness.

The total aggregated 480G internal fabric interface switching and routing throughput paired with 160G of external connectivity is the basis for forming platform solutions in packet oriented bandwidth hungry environments like 4G wireless and video transport. Combining several functions within a single blade design allows end users to maximize billable Centellis platform slots with revenue-generating application blades. This is accomplished with a combination of factory build options as well as several field options. Optional functions include telecom clock generation and distribution, SATA based disk drives and an AdvancedMC™ (AMC) site for general processing and/or packet processing functions.

A powerful on-board service processor executes all L2 and L3 switch functions, blade setup and hardware platform management functions independent of any processor AMC and/or SATA drive installed. This allows full, 100% utilization of the AMC based processor for end-user applications.
Hardware

SERVICE PROCESSOR
• NXP® QorIQ® P2020, dual-core processor, 1.0GHz

MEMORY
• Up to 4GB ECC-protected SDRAM, via (2) DDR3 memory DIMMs
  - Factory default – 2GB
• 64MB boot flash (NOR), dual-bank architecture
• 2GB (more possible) application flash
• 16MB CPU reset-persistent memory

BASE AND FABRIC INTERFACES
• PICMG 3.0 base interface switching – Gigabit Ethernet (1G)
• PICMG 3.1 fabric interface switching – 1G, 10G, 4 x 10G (KR), and 40G

AMC SITE
• Single AMC slot
• Mid-size AMC (AMC.0, AMC.1, AMC.2 and AMC.3 compliant)

STORAGE BAY
• Single HDD or solid state drive (SSD) bay
• Direct mount installation
• Standard SATA interface
  - Default configuration – NXP P2020 service processor via SATA bridge
  - Optional configuration – connection to AMC, port 2

FRONT PANEL INTERFACES
• Service processor
  - 1G Ethernet, RJ-45
  - RS-232 serial, RJ-45
• Base interface
  - 2x 10G Ethernet, SFP+
• Fabric interface
  - 2x 40G Ethernet, QSFP+
• Telecom Clock interfaces
  - 5x Inter-shelf interfaces, RJ-45
  - 1x Master/Slave interface, RJ-45
  - 2x BITS/SSU interfaces, RJ-45

REAR TRANSITION MODULE (RTM)
RTM-ATCA-F140
• Base interface
  - 2x 10G Ethernet, SFP+
  - 4x 1G Ethernet, SFP+
  • Fabric interface
    - 4x 10G Ethernet, SFP+
    - 1x 40G Ethernet, QSFP+

BLADE DIMENSIONS
• 8U form factor, 280 mm x 322.5 mm, single slot

RELEVANT STANDARDS
• PICMG 3.0 (form factor, IPMI, base interface, hot swap, RTM)
• PICMG 3.1
• Telcordia GR-1244-CORE [5] (if equipped with Telecom Clock function)
• ANSI T1.101 [9] (if equipped with Telecom Clock function)

OPERATING ENVIRONMENT
• Operating temperature range:
  -5 °C to +55 °C @ 90% non-condensing humidity
• Storage temperature range:
  -40 °C to +70 °C @ 95% relative humidity

Telecom Clock Characteristics (if equipped)

TELECOM CLOCK CHIP
• Semtech Topsync ACS9510

MODES OF OPERATION
• T0 normal operation: During normal (locked) operation, the T0 clocks shall be locked to the selected T1, T2 or T3 reference source.
• T0 free-run operation: During free-running mode, the T0 clocks shall be derived from the local oscillator.
• T0 hold-over operation: During holdover mode, the T0 clocks shall be based on the most recent valid reference available.
• T4 normal operation: During normal (locked) operation, the T4 clocks shall be locked to the selected T1 or T2 reference source.
• T4 hold-over and free-run operation: During free-running and holdover mode, the T4 clock shall be suppressed.

TIMING REFERENCE
• Traditional signal-based reference as defined by ITU-T G812 & G813 [3 & 4]
• Telcordia GR-1244-CORE [5]
• IEEE 1588v2

PERFORMANCE
• Stratum 3
**SRstackware® Software**

- L2 switch management software based on Linux providing a rich selection of features and protocols, e.g.
  - STP/RSTP/MSTP
  - VLAN, VLAN stacking (Q-in-Q)
  - LACP
  - Flow Control
  - Class of Service
  - GARP/GMRP/GVRP
  - SNMPv2, SNMPv3
  - ACL

- L3 switch management (optional ATCA-F140 add-on product)
  - IGMP v1/v2/v3, IGMP snooping/proxy
  - RIPv2, RIPng
  - OSPFv2
  - VRRP

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<tr>
<th>Regulatory Compliance</th>
<th>Description</th>
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| Designed to comply with NEBS | Telcordia GR-63-CORE, NEBS Physical Protection, Level 3  
| Designed to comply with ETSI | ETSI Storage, ETS 300 019-2-1, Class 1.2 equipment, Weather Protected, not Temperature Controlled Storage Locations  
ETSI Transportation, ETS 300 019-1-2, Class 2.3 equipment, Public Transportation  
ETSI Operation, ETS 300 019-1-3, Class 3.1(E) equipment, Partly Temperature Controlled Locations  
ETSI EN 300-132-2 Environmental Engineering (EE); Power supply interface at the input to telecommunications equipment; Part 2: Operated by direct current (dc)  
ETS-300-753, Equipment Engineering (EE); Acoustic noise emitted by telecommunications equipment |
| EMC | ETSI EN 300 386 Electromagnetic compatibility and Radio spectrum Matters (ERM); telecommunication network equipment; Electromagnetic Compatibility (EMC) requirements, Telecommunication equipment room (attended)  
FCC 47 CFR Part 15 Subpart B (US), Class A  
ECISPR 22, Limits and Methods of Measurement of Radio Disturbance Characteristics of Information Technology Equipment  
AS/NZS CISPR 22 (Australia/New Zealand), Limits and Methods of Measurement of Radio Disturbance Characteristics of Information Technology Equipment  
VCCI Class A (Japan), Voluntary Control Council for Interference by Information Technology Equipment |
| Safety | Compliance to UL/CSA 60950-1, EN 60950-1 and IEC 60950-1 CB Scheme. Marked with U.S. NRTL, Canadian Safety and CE Mark. |
SOLUTION SERVICES
SMART Embedded Computing provides a portfolio of solution services optimized to meet your needs throughout the product lifecycle. Design services help speed time-to-market. Deployment services include worldwide technical support. Renewal services enable product longevity and technology refresh.

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